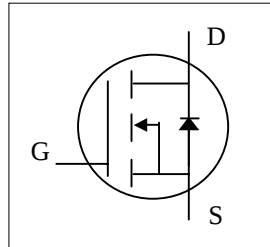
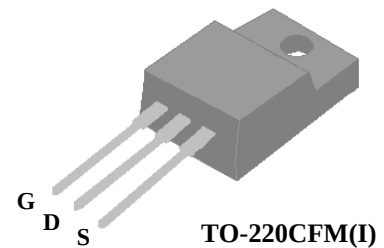




- ▼ 100%  $R_g$  & UIS Test
- ▼ Fast Switching Characteristic
- ▼ Simple Drive Requirement
- ▼ RoHS Compliant & Halogen-Free



|                       |               |
|-----------------------|---------------|
| $V_{DS} @ T_{j,max.}$ | 700V          |
| $R_{DS(ON)}$          | 0.13 $\Omega$ |
| $I_D^{3,4}$           | 26.2A         |



## Description

AP65SL130A series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The TO-220CFM package is widely preferred for all commercial-industrial through hole applications. The mold compound provides a high isolation voltage capability and low thermal resistance between the tab and the external heat-sink

## Absolute Maximum Ratings

| Symbol                    | Parameter                                           | Rating     | Units      |
|---------------------------|-----------------------------------------------------|------------|------------|
| $V_{DS}$                  | Drain-Source Voltage                                | 650        | V          |
| $V_{GS}$                  | Gate-Source Voltage                                 | $\pm 20$   | V          |
| $I_D @ T_C = 25^\circ C$  | Drain Current, $V_{GS} @ 10V^{3,4}$                 | 26.2       | A          |
| $I_D @ T_C = 100^\circ C$ | Drain Current, $V_{GS} @ 10V^{3,4}$                 | 16.5       | A          |
| $I_{DM}$                  | Pulsed Drain Current <sup>1</sup>                   | 66         | A          |
| dv/dt                     | MOSFET dv/dt Ruggedness ( $V_{DS} = 0 \dots 480V$ ) | 50         | V/ns       |
| $P_D @ T_C = 25^\circ C$  | Total Power Dissipation                             | 33.7       | W          |
| $P_D @ T_A = 25^\circ C$  | Total Power Dissipation                             | 1.92       | W          |
| $E_{AS}$                  | Single Pulse Avalanche Energy <sup>5</sup>          | 300        | mJ         |
| dv/dt                     | Peak Diode Recovery dv/dt <sup>6</sup>              | 15         | V/ns       |
| $T_{STG}$                 | Storage Temperature Range                           | -55 to 150 | $^\circ C$ |
| $T_J$                     | Operating Junction Temperature Range                | -55 to 150 | $^\circ C$ |

## Thermal Data

| Symbol | Parameter                                    | Value | Units        |
|--------|----------------------------------------------|-------|--------------|
| Rthj-c | Maximum Thermal Resistance, Junction-case    | 3.7   | $^\circ C/W$ |
| Rthj-a | Maximum Thermal Resistance, Junction-ambient | 65    | $^\circ C/W$ |



# AP65SL130AI

## Electrical Characteristics@T<sub>j</sub>=25°C(unless otherwise specified)

| Symbol              | Parameter                                      | Test Conditions                                          | Min. | Typ. | Max.  | Units |
|---------------------|------------------------------------------------|----------------------------------------------------------|------|------|-------|-------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA               | 650  | -    | -     | V     |
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =10V, I <sub>D</sub> =9.6A               | -    | -    | 0.13  | Ω     |
| V <sub>GS(th)</sub> | Gate Threshold Voltage                         | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA | 2    | -    | 5     | V     |
| g <sub>fs</sub>     | Forward Transconductance                       | V <sub>DS</sub> =10V, I <sub>D</sub> =14A                | -    | 25   | -     | S     |
| I <sub>DSS</sub>    | Drain-Source Leakage Current                   | V <sub>DS</sub> =480V, V <sub>GS</sub> =0V               | -    | -    | 100   | uA    |
| I <sub>GSS</sub>    | Gate-Source Leakage                            | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V               | -    | -    | ±100  | nA    |
| Q <sub>g</sub>      | Total Gate Charge                              | I <sub>D</sub> =14A                                      | -    | 82   | 131.2 | nC    |
| Q <sub>gs</sub>     | Gate-Source Charge                             | V <sub>DS</sub> =480V                                    | -    | 21   | -     | nC    |
| Q <sub>gd</sub>     | Gate-Drain ("Miller") Charge                   | V <sub>GS</sub> =10V                                     | -    | 33   | -     | nC    |
| t <sub>d(on)</sub>  | Turn-on Delay Time                             | V <sub>DD</sub> =300V                                    | -    | 24   | -     | ns    |
| t <sub>r</sub>      | Rise Time                                      | I <sub>D</sub> =14A                                      | -    | 42   | -     | ns    |
| t <sub>d(off)</sub> | Turn-off Delay Time                            | R <sub>G</sub> =3.3Ω                                     | -    | 74   | -     | ns    |
| t <sub>f</sub>      | Fall Time                                      | V <sub>GS</sub> =10V                                     | -    | 38   | -     | ns    |
| C <sub>iss</sub>    | Input Capacitance                              | V <sub>GS</sub> =0V                                      | -    | 3380 | 5408  | pF    |
| C <sub>oss</sub>    | Output Capacitance                             | V <sub>DS</sub> =100V                                    | -    | 90   | -     | pF    |
| C <sub>rss</sub>    | Reverse Transfer Capacitance                   | f=1.0MHz                                                 | -    | 11   | -     | pF    |
| R <sub>g</sub>      | Gate Resistance                                | f=1.0MHz                                                 | -    | 4.5  | 9     | Ω     |

## Source-Drain Diode

| Symbol          | Parameter                       | Test Conditions                          | Min. | Typ. | Max. | Units |
|-----------------|---------------------------------|------------------------------------------|------|------|------|-------|
| V <sub>SD</sub> | Forward On Voltage <sup>2</sup> | I <sub>S</sub> =14A, V <sub>GS</sub> =0V | -    | 0.85 | -    | V     |
| t <sub>rr</sub> | Reverse Recovery Time           | I <sub>S</sub> =14A, V <sub>GS</sub> =0V | -    | 430  | -    | ns    |
| Q <sub>rr</sub> | Reverse Recovery Charge         | di/dt=30A/μs                             | -    | 2.5  | -    | μC    |

### Notes:

- 1.Pulse width limited by max. junction temperature.
- 2.Pulse test
- 3.Limited by max. junction temperature. Maximum duty cycle D=0.75
- 4.Ensure that the junction temperature does not exceed T<sub>Jmax</sub>.
- 5.Starting T<sub>j</sub>=25°C , V<sub>DD</sub>=50V , L=150mH , R<sub>G</sub>=25Ω
- 6.I<sub>SD</sub> ≤ I<sub>D</sub>, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, starting T<sub>J</sub> = 25°C

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

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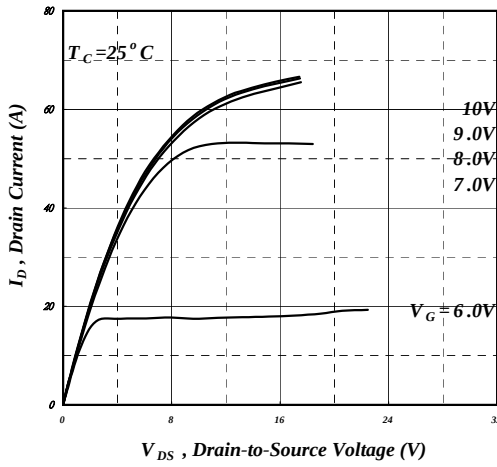


Fig 1. Typical Output Characteristics

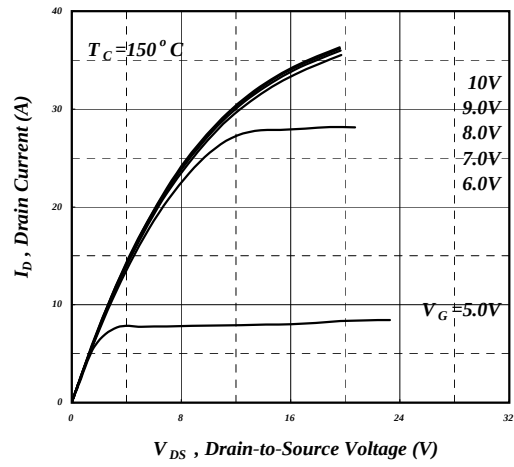


Fig 2. Typical Output Characteristics

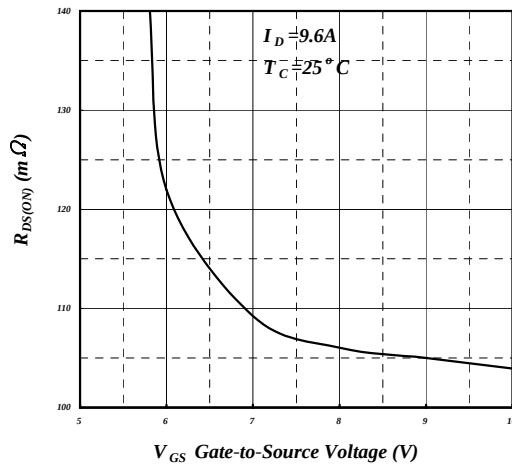


Fig 3. On-Resistance v.s. Gate Voltage

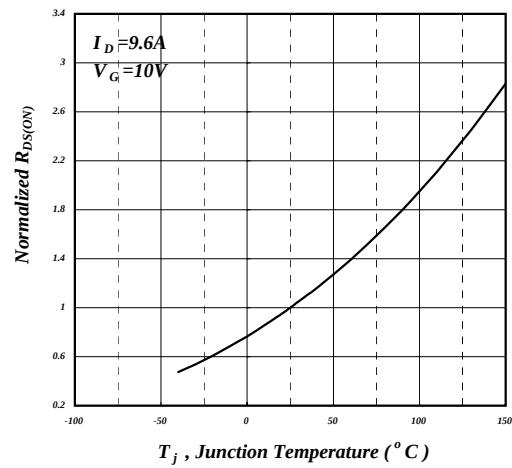


Fig 4. Normalized On-Resistance v.s. Junction Temperature

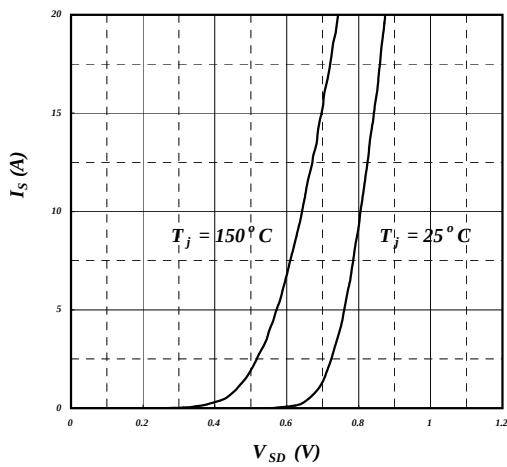


Fig 5. Forward Characteristic of Reverse Diode

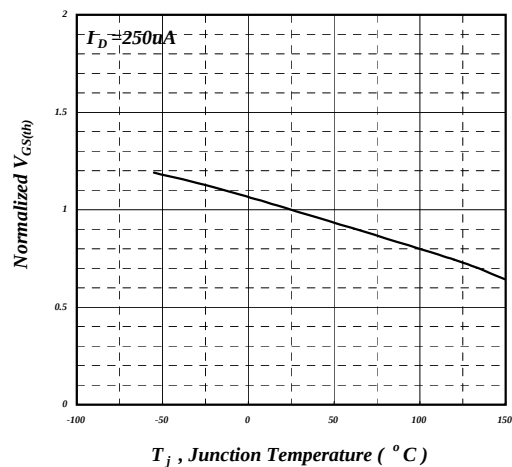


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

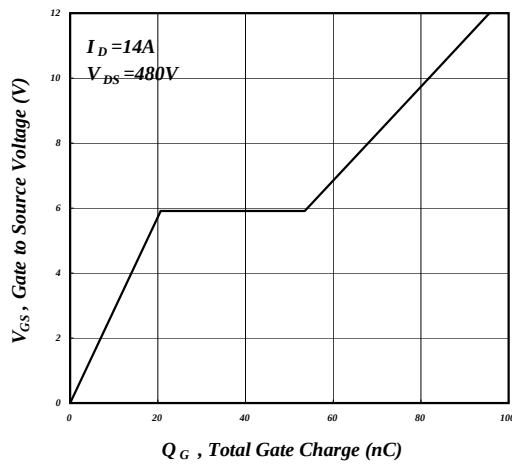


Fig 7. Gate Charge Characteristics

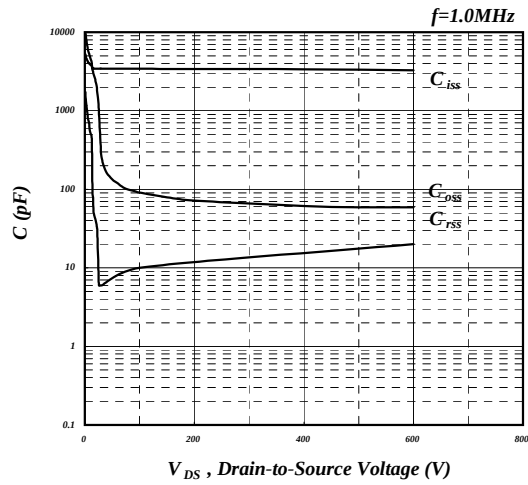


Fig 8. Typical Capacitance Characteristics

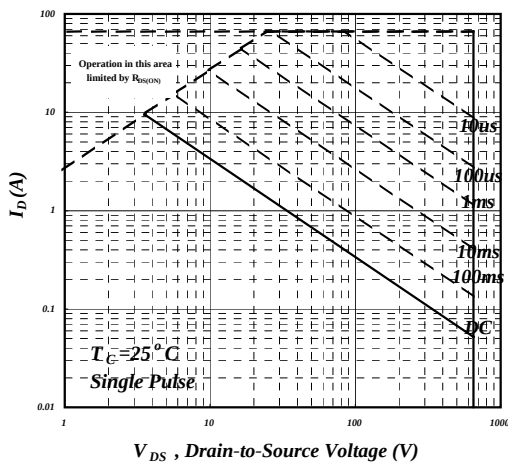


Fig 9. Maximum Safe Operating Area

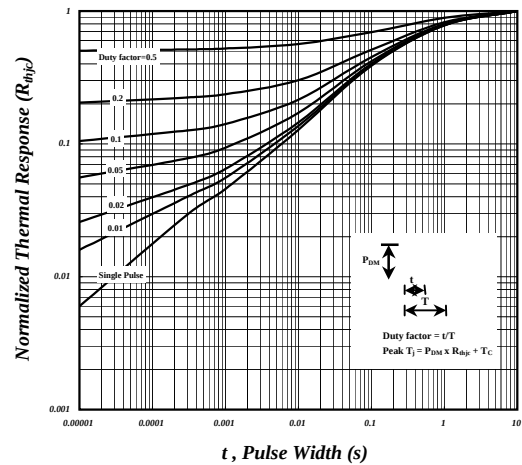


Fig10. Effective Transient Thermal Impedance

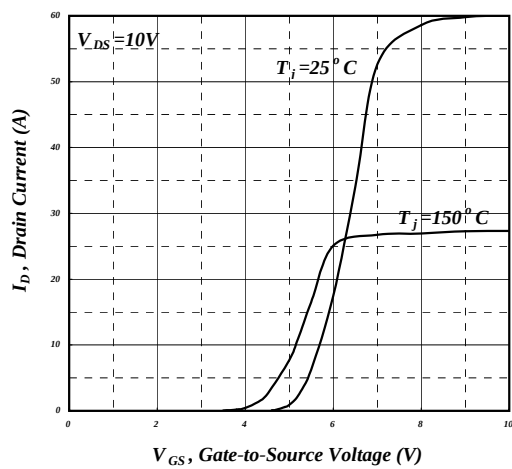


Fig 11. Transfer Characteristics

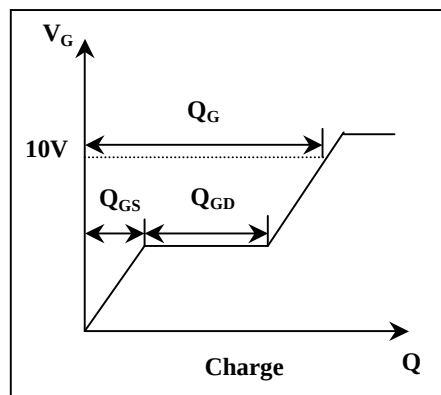


Fig 12. Gate Charge Waveform

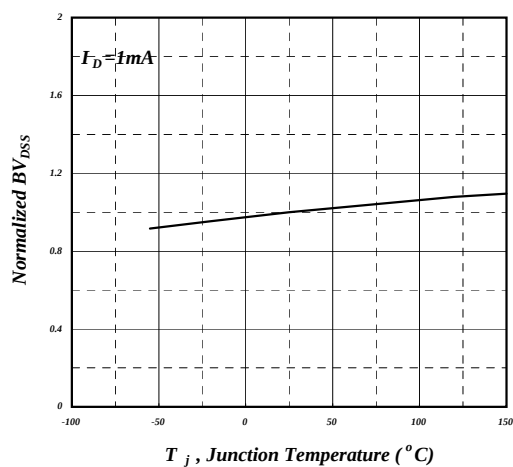


Fig 13. Normalized  $BV_{DSS}$  v.s. Junction Temperature

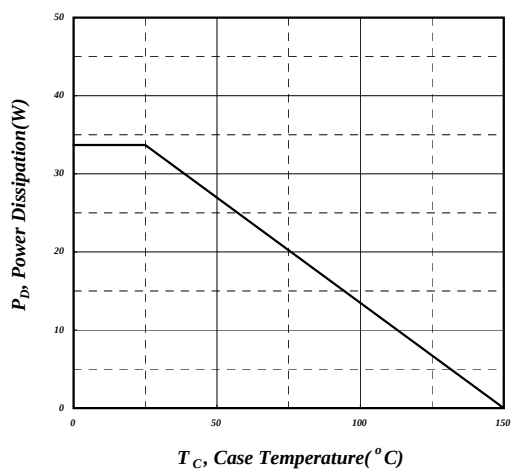


Fig 14. Total Power Dissipation

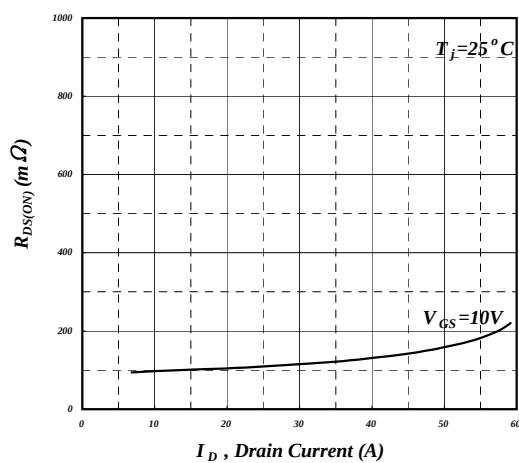


Fig 15. Typ. Drain-Source on State Resistance



# AP65SL130AI

## MARKING INFORMATION

